General Purpose Transistors

NPN Silicon

Features

- Moisture Sensitivity Level: 1
- ESD Rating Human Body Model: >4000 V
 - Machine Model: >400 V
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-Emitter Voltage BC846 BC847, BC850 BC848, BC849	V _{CEO}	65 45 30	Vdc
Collector-Base Voltage BC846 BC847, BC850 BC848, BC849	V _{CBO}	80 50 30	Vdc
Emitter-Base Voltage BC846 BC847, BC850 BC848, BC849	V _{EBO}	6.0 6.0 5.0	Vdc
Collector Current - Continuous	I _C	100	mAdc

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

THERMAL CHARACTERISTICS

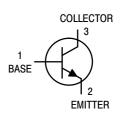
Characteristic	Symbol	Max	Unit
Total Device Dissipation FR-5 Board, (Note 1) T _A = 25°C	P _D	225	mW
Derate above 25°C		1.8	mW/°C
Thermal Resistance, Junction-to-Ambient (Note 1)	$R_{ heta JA}$	556	°C/W
Total Device Dissipation Alumina Substrate (Note 2) T _A = 25°C Derate above 25°C	P _D	300	mW mW/°C
20.000 0.0000			,
Thermal Resistance, Junction-to-Ambient (Note 2)	$R_{ heta JA}$	417	°C/W
Junction and Storage Temperature Range	T _J , T _{stg}	-55 to +150	°C

- 1. FR-5 = $1.0 \times 0.75 \times 0.062$ in.
- 2. Alumina = $0.4 \times 0.3 \times 0.024$ in 99.5% alumina.



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SOT-23 CASE 318 STYLE 6

MARKING DIAGRAM



XX = Device Code
M = Date Code*
• Pb-Free Package

(Note: Microdot may be in either location)

*Date Code orientation and/or overbar may vary depending upon manufacturing location.

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 5 of this data sheet.

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Chara	Symbol	Min	Тур	Max	Unit	
OFF CHARACTERISTICS				•	•	•
Collector – Emitter Breakdown Voltage (I _C = 10 mA)	BC846A,B BC847A,B,C, BC850B,C BC848A,B,C, BC849B,C	V _{(BR)CEO}	65 45 30	- - -	- - -	V
Collector – Emitter Breakdown Voltage ($I_C = 10 \mu A, V_{EB} = 0$)	BC846A,B BC847A,B,C BC850B,C BC848A,B,C, BC849B,C	V _{(BR)CES}	80 50 30	- - -	- - -	V
Collector – Base Breakdown Voltage ($I_C = 10 \mu A$)	BC846A,B BC847A,B,C, BC850B,C BC848A,B,C, BC849B,C	V _{(BR)CBO}	80 50 30	- - -	- - -	V
Emitter – Base Breakdown Voltage ($I_E = 1.0 \mu A$)	BC846A,B BC847A,B,C, BC850B,C BC848A,B,C, BC849B,C	V _{(BR)EBO}	6.0 6.0 5.0	- - -	- - -	V
Collector Cutoff Current (V _{CB} = 30 V)	Ісво		_ _	15 5.0	nA μA	
ON CHARACTERISTICS				•		!
DC Current Gain ($I_C = 10 \mu A, V_{CE} = 5.0 V$)	BC846A, BC847A, BC848A BC846B, BC847B, BC848B BC847C, BC848C	h _{FE}	- - -	90 150 270	- - -	
$(I_C = 2.0 \text{ mA}, V_{CE} = 5.0 \text{ V})$	BC846A, BC847A, BC848A BC846B, BC847B, BC848B, BC849B, BC850B BC847C, BC848C, BC849C, BC850C		110 200 420	180 290 520	220 450 800	
Collector - Emitter Saturation Voltage	$I_C = 10 \text{ mA}, I_B = 0.5 \text{ mA})$ $I_C = 100 \text{ mA}, I_B = 5.0 \text{ mA})$	V _{CE(sat)}	-	_ _	0.25 0.6	V
Base – Emitter Saturation Voltage ($I_C = 10 \text{ mA}$, $I_B = 0.5 \text{ mA}$) ($I_C = 100 \text{ mA}$, $I_B = 5.0 \text{ mA}$)			-	0.7 0.9	- -	V
Base – Emitter Voltage (I_C = 2.0 mA, V_{CE} = 5.0 V) (I_C = 10 mA, V_{CE} = 5.0 V)			580 -	660 -	700 770	mV
SMALL-SIGNAL CHARACTERISTICS	3			•	•	•
Current – Gain – Bandwidth Product (I_C = 10 mA, V_{CE} = 5.0 Vdc, f = 100 MHz)			100	_	_	MHz
Output Capacitance (V _{CB} = 10 V, f = 1	C _{obo}	-	-	4.5	pF	
Noise Figure (I_C = 0.2 mA, V_{CE} = 5.0 Vdc, R_S = 2.0 k Ω , f = 1.0 kHz, BW = 200 Hz)	NF	- -	_ _	10 4.0	dB	

BC847, BC848, BC849, BC850

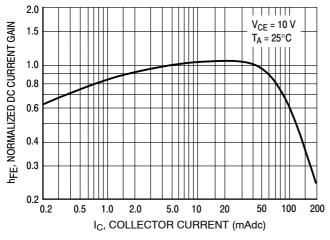


Figure 1. Normalized DC Current Gain

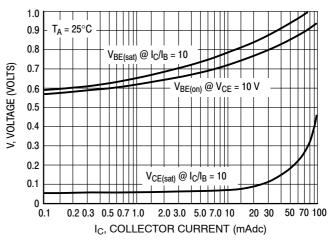


Figure 2. "Saturation" and "On" Voltages

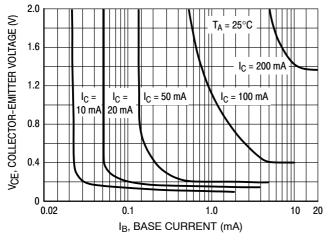


Figure 3. Collector Saturation Region

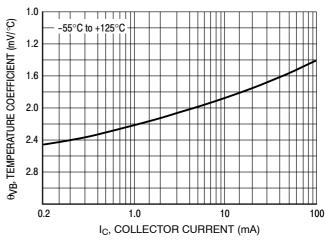


Figure 4. Base-Emitter Temperature Coefficient

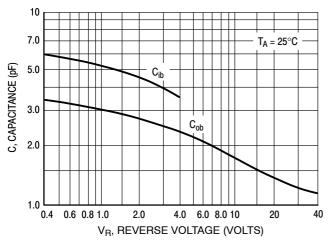


Figure 5. Capacitances

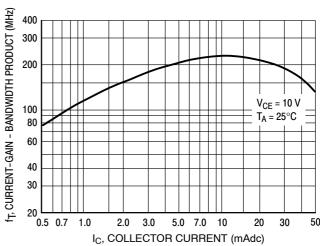


Figure 6. Current-Gain - Bandwidth Product

BC846

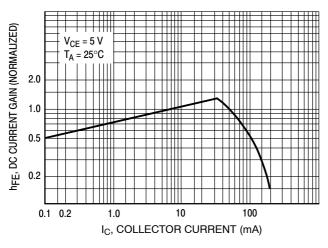


Figure 7. DC Current Gain

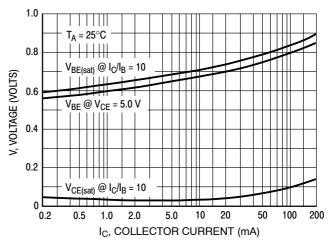


Figure 8. "On" Voltage

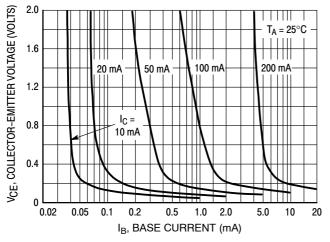


Figure 9. Collector Saturation Region

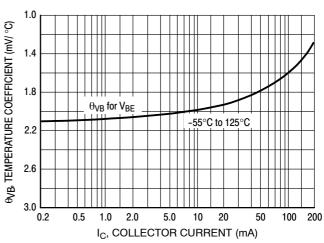


Figure 10. Base-Emitter Temperature Coefficient

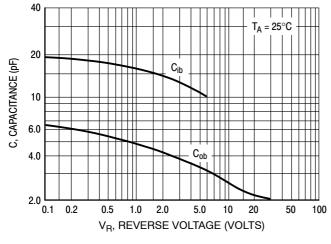


Figure 11. Capacitance

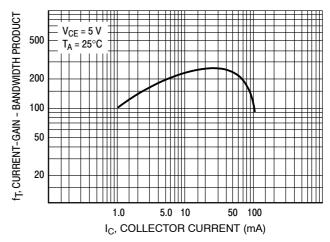


Figure 12. Current-Gain - Bandwidth Product

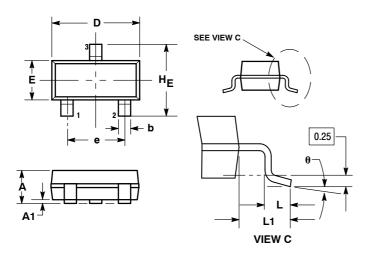
ORDERING INFORMATION

Device	Marking	Package	Shipping [†]
BC846ALT1G		SOT-23 (Pb-Free)	3,000 / Tape & Reel
BC846ALT3G	1A	SOT-23 (Pb-Free)	10,000 / Tape & Reel
BC846BLT1G	10	SOT-23 (Pb-Free)	3,000 / Tape & Reel
BC846BLT3G	1B	SOT-23 (Pb-Free)	10,000 / Tape & Reel
BC847ALT1G		SOT-23 (Pb-Free)	3,000 / Tape & Reel
BC847ALT3G	1E	SOT-23 (Pb-Free)	10,000 / Tape & Reel
BC847BLT1G	_	SOT-23 (Pb-Free)	3,000 / Tape & Reel
BC847BLT3G	1F	SOT-23 (Pb-Free)	10,000 / Tape & Reel
BC847CLT1G		SOT-23 (Pb-Free)	3,000 / Tape & Reel
BC847CLT3G	1G	SOT-23 (Pb-Free)	10,000 / Tape & Reel
BC848ALT1G	1J	SOT-23 (Pb-Free)	
BC848BLT1G		SOT-23 (Pb-Free)	3,000 / Tape & Reel
BC848BLT3G	1K	SOT-23 (Pb-Free)	10,000 / Tape & Reel
BC848CLT1G		SOT-23 (Pb-Free)	3,000 / Tape & Reel
BC848CLT3G	1L	SOT-23 (Pb-Free)	10,000 / Tape & Reel
BC849BLT1G		SOT-23 (Pb-Free)	3,000 / Tape & Reel
BC849BLT3G	2B	SOT-23 (Pb-Free)	10,000 / Tape & Reel
BC849CLT1G		SOT-23 (Pb-Free)	3,000 / Tape & Reel
BC849CLT3G	2C	SOT-23 (Pb-Free)	10,000 / Tape & Reel
BC850BLT1G	2F	SOT-23 (Pb-Free)	
BC850CLT1G	2G	SOT-23 (Pb-Free)	3,000 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

PACKAGE DIMENSIONS

SOT-23 (TO-236) CASE 318-08 **ISSUE AN**



NOTES:

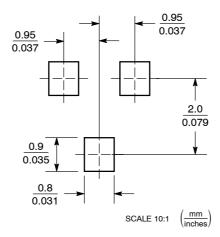
- DIMENSIONING AND TOLERANCING PER ANSI
- Y14.5M, 1982. CONTROLLING DIMENSION: INCH.
- MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL
- 318-01 THRU -07 AND -09 OBSOLETE, NEW STANDARD 318-08

	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	0.89	1.00	1.11	0.035	0.040	0.044
A1	0.01	0.06	0.10	0.001	0.002	0.004
b	0.37	0.44	0.50	0.015	0.018	0.020
С	0.09	0.13	0.18	0.003	0.005	0.007
D	2.80	2.90	3.04	0.110	0.114	0.120
E	1.20	1.30	1.40	0.047	0.051	0.055
е	1.78	1.90	2.04	0.070	0.075	0.081
L	0.10	0.20	0.30	0.004	0.008	0.012
L1	0.35	0.54	0.69	0.014	0.021	0.029
HE	2.10	2.40	2.64	0.083	0.094	0.104

STYLE 6:

- PIN 1. BASE
 - 2 **EMITTER**
- COLLECTOR

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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